

NPN power transistor

Features

■ NPN transistor

Applications

General purpose switching and amplifier transistor

Description

The device is manufactured in Planar technology with "Base Island" layout. The resulting transistor shows exceptional high gain performance coupled with very low saturation voltage. The PNP type is the BD240C.

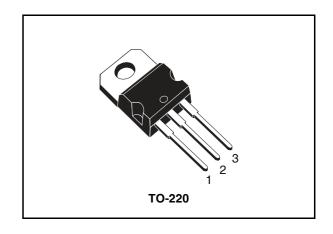


Figure 1. Internal schematic diagram

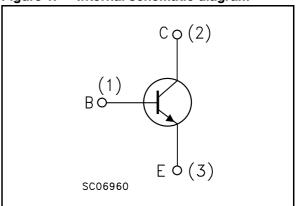


Table 1. Device summary

Order code	Marking	Package	Packaging
BD239C	BD239C	TO-220	Tube

Electrical ratings BD239C

1 Electrical ratings

Table 2. Absolute maximum rating

Symbol	Parameter	Value	Unit
V_{CER}	Collector-emitter voltage ($R_{BE} = 100\Omega$)	115	V
V _{CEO}	Collector-base voltage (I _B = 0)	100	V
V _{EBO}	Emitter-base voltage ($I_C = 0$)	5	V
Ic	Collector current	2	Α
I _{CM}	Collector peak current	4	Α
Ι _Β	Base current	0.6	Α
P _{TOT}	Total dissipation at T _{case} ≤ 25°C	30	W
P _{TOT}	Total dissipation at T _{amb} ≤ 25°C	2	W
T _{stg}	Storage temperature	-65 to 150	°C
T _J	Max. operating junction temperature	150	°C

2 Electrical characteristics

(T_{case} = 25°C unless otherwise specified)

Table 3. Electrical characteristics

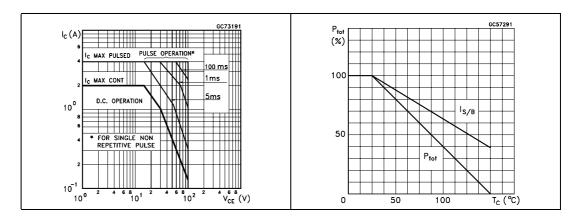
Symbol	Parameter	Test Condit	ions	Min.	Тур.	Max.	Unit
I _{CES}	Collector cut-off current (V _{BE} = 0)	V _{CE} = 100V				0.2	mA
I _{CEO}	Collector cut-off current (I _B = 0)	V _{CE} = 60V				0.3	mA
I _{EBO}	Emitter cut-off current (I _C = 0)	V _{EB} = 5V				1	mA
V _{CEO(sus)} (1)	Collector-emitter sustaining voltage (I _B = 0)	I _C = 30mA		100			V
V _{CE(sat)} (1)	Collector-emitter saturation voltage	I _C = 1A I _B	; = 0.2A			0.7	V
V _{BE} ⁽¹⁾	Base-emitter voltage	I _C = 1A V	_{CE} = 4V			1.3	٧
h _{FE}	DC current gain	-	_{CE} = 4V _{CE} = 4V	40 15			

Note (1) Pulsed duration = 300 μ s, duty cycle \leq 1.5%

2.1 Electrical characteristic (curves)

Figure 2. Safe operating area

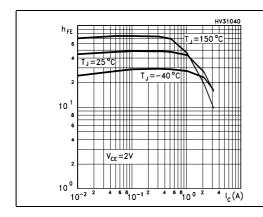
Figure 3. Derating curve



Electrical characteristics BD239C

Figure 4. DC current gain

Figure 5. DC current gain



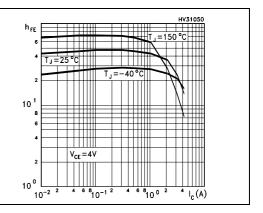
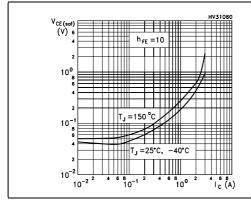


Figure 6. Collector-emitter saturation voltage

Figure 7. Base-emitter saturation voltage



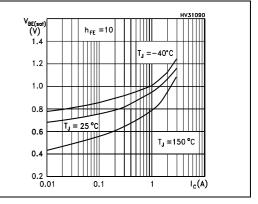
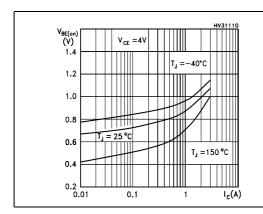
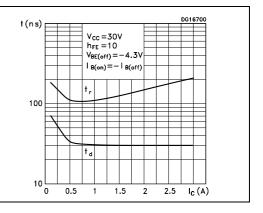


Figure 8. Base-emitter on voltage

Figure 9. Resistive load switching time





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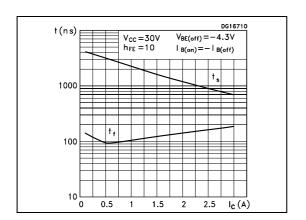
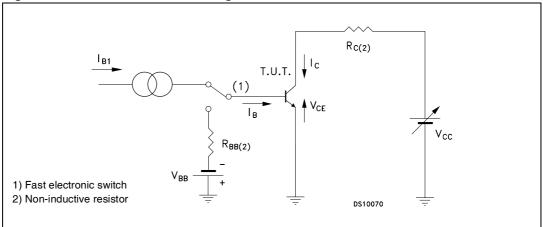


Figure 10. Resistive load switching time

2.2 Test circuit

Figure 11. Resistive load switching test circuit

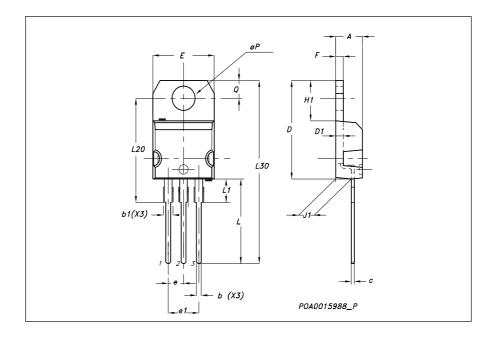


3 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com

TO-220 Mechanical data

DIM.		mm.	
	MIN.	TYP	MAX.
Α	4.40		4.60
b	0.61		0.88
b1	1.14		1.70
С	0.49		0.70
D	15.25		15.75
D1		1.27	
E	10		10.40
е	2.40		2.70
e1	4.95		5.15
F	1.23		1.32
H1	6.20		6.60
J1	2.40		2.72
L	13		14
L1	3.50		3.93
L20		16.40	
L30		28.90	
øΡ	3.75		3.85
Q	2.65		2.95



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Revision history BD239C

4 Revision history

Table 4. Revision history

Date	Revision	Changes
01-April-1999	1	Initial release.
02-Jul-2007	2	Figures 2,3,4,5,6,7,8,9 and figure 10 have been added.

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